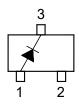
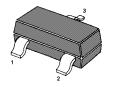
BAS16-AH

Silicon Epitaxial Planar Switching Diode

Features

- Small package
- Low forward voltage
- Fast reverse recovery time
- Small total capacitance
- AEC-Q101 Qualified
- Halogen and Antimony Free(HAF), RoHS compliant





1. Anode 2. NC 3. Cathode SOT-23 Plastic Package

Applications

• Ultra high speed switching application

Absolute Maximum Ratings (T_a = 25 °C)

Parameter	Symbol	Value	Unit	
Repetitive Peak Reverse Voltage		V_{RRM}	100	V
Continuous Reverse Voltage	V_R	80	V	
Continuous Forward Current	lF	215	mA	
Repetitive Peak Forward Current	I _{FRM}	500	mA	
Non-Repetitive Peak Forward Surge Current	t = 1 µs t = 1 ms t = 1 s	IFSM	4 1 0.5	А
Power Dissipation		P _{tot}	350	mW
Junction Temperature		Tj	150	°C
Storage Temperature Range		T _{stg}	- 55 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit	
Thermal Resistance from Junction to Ambient 1)	Reja	357	°C/W	

¹⁾ Device mounted on FR-4 PCB with minimum recommended pad layout.



BAS16-AH

Characteristics at T_a = 25 ∘C

Parameter	Symbol	Min.	Max.	Unit
Forward Voltage at $I_F = 1$ mA at $I_F = 10$ mA at $I_F = 50$ mA at $I_F = 150$ mA	V _F V _F V _F	- - - -	715 855 1 1.25	mV mV V
Reverse Current at V_R = 25 V at V_R = 80V at V_R = 25 V, T_J = 150 °C at V_R = 80 V, T_J = 150 °C	Ir Ir Ir Ir	- - - -	30 0.5 30 50	nA μA μA μA
Reverse Breakdown Voltage at I _R = 100 µA	V _{(BR)R}	80	-	V
Diode Capacitance at $V_R = 0 V$, $f = 1 MHz$	C _d	-	2	pF
Reverse Recovery Time at I_F = 10 mA, I_{rr} = 0.1 x I_R , V_R = 6 V, R_L = 100 Ω	t _{rr}	-	4	ns



Electrical Characteristics Curves

E. 4 5 5 .. 6

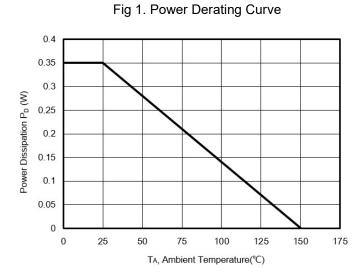


Fig 2. Capacitance Characteristics

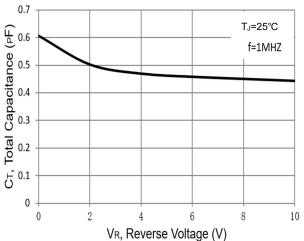


Fig 3. Reverse Characteristics

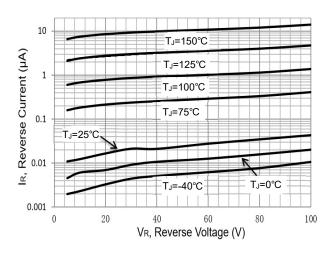
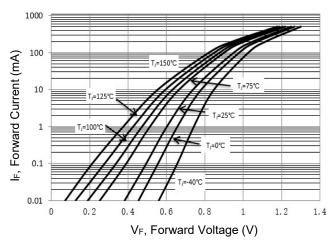


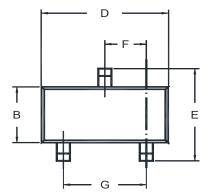
Fig 4. Forward Characteristics

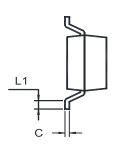


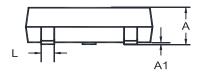


Package Outline (Dimensions in mm)

SOT-23

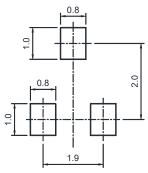






Unit	Α	A1	В	C	D	Е	F	G	L	L1
	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
mm	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

Recommended Soldering Footprint



Packing information

5 .	Tape Width	Pit	tch	Reel	Size		
Package	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity	
SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	

Marking information

" 5D " = Part No.

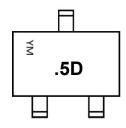
"•" = HAF (Halogen and Antimony Free)

"YM" = Date Code Marking

"Y" = Year

"M" = Month

Font type: Arial



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